## P-Channel Enhancement Mode Vertical DMOS FETs

## Features

- Low threshold (-2.4V max.)
- High input impedance
- Low input capacitance (125pF max.)
- Fast switching speeds
- Low on-resistance
- Free from secondary breakdown
- Low input and output leakage


## Applications

- Logic level interfaces - ideal for TTL and CMOS
- Solid state relays
- Battery operated systems
- Photo voltaic drives
- Analog switches
- General purpose line drivers
- Telecom switches


## General Description

This low threshold enhancement-mode (normally-off) transistor utilizes a vertical DMOS structure and Supertex's wellproven silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and with the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

## Ordering Information

| Device | Package Options |  | $\underset{\text { DSs }}{\substack{\mathrm{BV}_{\mathrm{D}}}}$ | $\mathbf{R}_{\substack{\mathrm{Ds}(\mathrm{O})}}$ | $\underset{\substack{(\max (T \mathrm{H}) \\(\mathrm{V})}}{\mathbf{V}^{(2)}}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{DO}(\mathrm{ON})} \\ & (\mathrm{min}) \\ & (\mathrm{A}) \end{aligned}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | TO-243AA (SOT-89) | Die* |  |  |  |  |
| TP2502 | TP2502N8-G | TP2502ND | -20 | 2.0 | -2.4 | -2.0 |

-G indicates package is RoHS compliant ('Green')

* MIL visual screening available.



## Absolute Maximum Ratings

| Parameter | Value |
| :--- | ---: |
| Drain-to-source voltage | $\mathrm{BV}_{\text {DSS }}$ |
| Drain-to-gate voltage | $\mathrm{BV}_{\text {DGS }}$ |
| Gate-to-source voltage | $\pm 20 \mathrm{~V}$ |
| Operating and storage temperature | $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |
| Soldering temperature* | $300^{\circ} \mathrm{C}$ |

[^0]
## Thermal Characteristics

| Package | $\underset{\left(\text { continuous }^{t}\right.}{(\mathrm{mA})} \underset{\mathrm{I}_{\mathrm{D}}}{t}$ | (pulsed) <br> (A) | Power Dissipation <br> @ $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ <br> (W) | $\begin{gathered} \boldsymbol{\theta}_{\text {jc }} \\ \left({ }^{\circ} \mathrm{C} / \mathrm{W}\right) \end{gathered}$ | $\begin{gathered} \boldsymbol{\theta}_{\mathrm{ja}} \\ \left({ }^{\circ} \mathrm{C} / \mathrm{W}\right) \end{gathered}$ | $\begin{aligned} & \mathrm{I}_{\mathrm{DR}}{ }^{\dagger} \\ & (\mathrm{mA}) \end{aligned}$ | $I_{\text {DRM }}$ <br> (A) |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TO-243AA | -630 | -3.3 | $1.6{ }^{\ddagger}$ | 15 | $78^{ \pm}$ | -630 | -3.3 |

$\dagger I_{D}$ (continuous) is limited by max rated $T_{j}$.
$\ddagger$ Mounted on FR5 board, $25 \mathrm{~mm} \times 25 \mathrm{~mm} \times 1.57 \mathrm{~mm}$.
Electrical Characteristics ( $T_{A}=25^{\circ} \mathrm{C}$ unless otherwise specified $)$

| Sym | Parameter | Min | Typ | Max | Units | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{BV}_{\text {DSS }}$ | Drain-to-source breakdown voltage | -20 | - | - | V | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-2.0 \mathrm{~mA}$ |
| $\mathrm{V}_{\text {GS(th) }}$ | Gate threshold voltage | -1.0 | - | -2.4 | V | $V_{G S}=V_{D S}, I_{D}=-1.0 \mathrm{~mA}$ |
| $\Delta \mathrm{V}_{\text {GS(th) }}$ | Change in $\mathrm{V}_{\text {GS(th) }}$ with temperature | - | 3.0 | 4.5 | $\mathrm{mV} /{ }^{\circ} \mathrm{C}$ | $V_{G S}=V_{D S}, I_{D}=-1.0 \mathrm{~mA}$ |
| $\mathrm{I}_{\text {GSS }}$ | Gate body leakage | - | - | -100 | nA | $\mathrm{V}_{\mathrm{GS}}= \pm 20 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=0 \mathrm{~V}$ |
| $I_{\text {DSS }}$ | Zero gate voltage drain current | - | - | -100 | $\mu \mathrm{A}$ | $\mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=$ Max Rating |
|  |  |  | - | -10 | mA | $\begin{aligned} & V_{D S}=0.8 \mathrm{Max} \text { Rating, } \\ & \mathrm{V}_{\mathrm{GS}}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=125^{\circ} \mathrm{C} \end{aligned}$ |
| $I_{\text {D(ON) }}$ | On-state drain current | -0.4 | -0.7 | - | A | $\mathrm{V}_{\mathrm{GS}}=-5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=-15 \mathrm{~V}$ |
|  |  | -2.0 | -3.3 | - |  | $V_{G S}=-10 \mathrm{~V}, \mathrm{~V}_{\mathrm{DS}}=-15 \mathrm{~V}$ |
| $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ | Static drain-to-source on-state resistance | - | 2.0 | 3.5 | $\Omega$ | $V_{G S}=-5.0 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-250 \mathrm{~mA}$ |
|  |  |  | 1.5 | 2.0 |  | $V_{G S}=-10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-1.0 \mathrm{~A}$ |
| $\Delta \mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ | Change in $\mathrm{R}_{\mathrm{DS}(\mathrm{ON})}$ with temperature | - | 0.75 | 1.2 | \%/ ${ }^{\circ} \mathrm{C}$ | $V_{G S}=-10 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-1.0 \mathrm{~A}$ |
| $\mathrm{G}_{\text {FS }}$ | Forward transconductance | 300 | 650 | - | mmho | $V_{D S}=-15 \mathrm{~V}, \mathrm{I}_{\mathrm{D}}=-1.0 \mathrm{~A}$ |
| $\mathrm{C}_{\text {ISS }}$ | Input capacitance | - | - | 125 | pF | $\begin{aligned} & V_{G S}=0 \mathrm{~V}, \\ & V_{D S}=-20 \mathrm{~V}, \\ & f=1.0 \mathrm{MHz} \end{aligned}$ |
| $\mathrm{C}_{\text {OSS }}$ | Common source output capacitance | - | - | 70 |  |  |
| $\mathrm{C}_{\text {RSS }}$ | Reverse transfer capacitance | - | - | 25 |  |  |
| $\mathrm{t}_{\mathrm{d}(\mathrm{ON})}$ | Turn-on delay time | - | - | 10 | ns | $\begin{aligned} & V_{\mathrm{DD}}=-20 \mathrm{~V}, \\ & \mathrm{I}_{\mathrm{D}}=-1.0 \mathrm{~A}, \\ & \mathrm{R}_{\mathrm{GEN}}=25 \Omega \end{aligned}$ |
| $\mathrm{t}_{\mathrm{r}}$ | Rise time | - | - | 11 |  |  |
| $\mathrm{t}_{\mathrm{d} \text { (OFF) }}$ | Turn-off delay time | - | - | 15 |  |  |
| $\mathrm{t}_{\mathrm{f}}$ | Fall time | - | - | 12 |  |  |
| $\mathrm{V}_{\text {SD }}$ | Diode forward voltage drop | - | -1.3 | -2.0 | V | $\mathrm{V}_{G S}=0 \mathrm{~V}, \mathrm{I}_{\text {SD }}=-1.5 \mathrm{~A}$ |
| $t_{\text {rr }}$ | Reverse recovery time | - | 300 | - | ns | $V_{G S}=0 \mathrm{~V}, \mathrm{I}_{\text {SD }}=-1.5 \mathrm{~A}$ |

## Notes:

1. All D.C. parameters $100 \%$ tested at $25^{\circ} \mathrm{C}$ unless otherwise stated. (Pulse test: $300 \mu$ s pulse, $2 \%$ duty cycle.)
2. All A.C. parameters sample tested.

## Switching Waveforms and Test Circuit



PULSE GENERATOR


## Typical Performance Curves








## Typical Performance Curves (cont.)







## 3-Lead TO-243AA (SOT-89) Package Outline (N8)



Top View


Side View

| Symbol |  | A | b | b1 | C | D | D1 | E | E1 | e | e1 | H | L |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Dimensions (mm) | MIN | 1.40 | 0.44 | 0.36 | 0.35 | 4.40 | 1.62 | 2.29 | 2.13 | $\begin{aligned} & 1.50 \\ & \text { BSC } \end{aligned}$ | $\begin{aligned} & 3.00 \\ & \text { BSC } \end{aligned}$ | 3.94 | 0.89 |
|  | NOM | - | - | - | - | - | - | - | - |  |  | - | - |
|  | MAX | 1.60 | 0.56 | 0.48 | 0.44 | 4.60 | 1.83 | 2.60 | 2.29 |  |  | 4.25 | 1.20 |

JEDEC Registration TO-243, Variation AA, Issue C, July 1986.
Drawings not to scale.
Supertex Doc. \#: DSPD-3TO243AAN8, Version D070908.
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to http://www.supertex.com/packaging.html.)

[^1]
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[^0]:    Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

    * Distance of 1.6 mm from case for 10 seconds.

[^1]:    Supertex inc. does not recommend the use of its products in life support applications, and will not knowingly sell them for use in such applications unless it receives an adequate "product liability indemnification insurance agreement." Supertex inc. does not assume responsibility for use of devices described, and limits its liability to the replacement of the devices determined defective due to workmanship. No responsibility is assumed for possible omissions and inaccuracies. Circuitry and specifications are subject to change without notice. For the latest product specifications refer to the Supertex inc. website: http//www.supertex.com.

